



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of

KANAYAMA et al.

Atty. Ref.: 1417-495; Confirmation No. 8472

Appl. No. 10/522,725

TC/A.U. 1796

Filed: September 22, 2005

Examiner: Frank

For: LOW-HEAT ACCUMULATING THERMOPLASTIC RESIN COMPOSITION AND  
MOLDED PRODUCT

\* \* \* \* \*

February 19, 2009

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**AMENDMENT**

Please amend the above-identified application as follows: